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Substitute for Form 1449A/PTO				Application Number.	TO 10 603,711		
	INFORMATIO	N DISCLOSURE		Filing Date	Horavith 6/25/03		
INFORMATION DISCLOSURE STATEMENT BY APPLICANT				First Named Inventor	Taylor R. Elland		
STATEMENT BY APPLICANT				Group Art Unit	780 281S		
(use as many sheets as necessary)				Examiner Name	Jasmine 1880 Clark		
Sheet	1	of	2	Attorney Docket No.	TI-30963.1		

		 -		U.S. PATENT DOCUM	ENTS	
		U.S. Patent I	Document	Name of Patentee or Applicant of Cited Doc.	Date of Pub. of Cited Doc. (mm-dd-yyyy)	
Exam. Initials	Cite No.1	Number	Kind Code ² (if known)			Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
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		Office ³	Number ⁴	Kind Code ² (if known)	or Applicant of Cited Doc.	of Cited Doc. (mm-dd-yyyy)	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T ₀
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¹Unique citation designation number. ²See attached Kinds of U.S. Patent Documents. ³Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶Applicant is to place a check mark here if English language Translation is attached.

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		Substitute for For	11 1443/07 10		Application Number TBD							
	IN	FORMATION	DISCLOSURE		Filing Date		Herewith					
		TATEMENT BY			First Named Inventor	Taylor R. Efland						
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Sheet		2		2	Attorney Docket No. 77-30963.1							
			OTHER PR	OR ART - NON PA	TENT LITERATURE DOCUM	MENTS						
Exam. Initials*	Cite No. ¹				he article (when appropriate), e-issue number(s), publisher,			al, T ²				
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